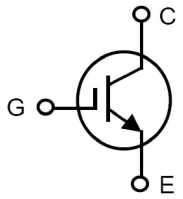
IXYS

1200V XPT™ GenX4™ IGBT

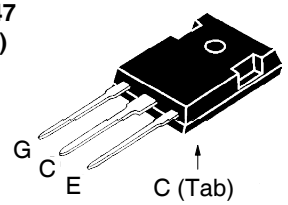
IXYH40N120A4

V_{CES} = 1200V
I_{C110} = 40A
$V_{CE(sat)}$ ≤ 1.80V
$t_{fi(typ)}$ = 220ns

Ultra Low-Vsat PT IGBT for up to 5kHz Switching



TO-247 (IXYH)



G = Gate C = Collector
E = Emitter Tab = Collector

Symbol	Test Conditions	Maximum Ratings	
V_{CES}	T_J = 25°C to 175°C	1200	V
V_{CGR}	T_J = 25°C to 175°C, R_{GE} = 1MΩ	1200	V
V_{GES}	Continuous	±20	V
V_{GEM}	Transient	±30	V
I_{C25}	T_C = 25°C	140	A
I_{C110}	T_C = 110°C	40	A
I_{CM}	T_C = 25°C, 1ms	275	A
SSOA (RBSOA)	V_{GE} = 15V, T_{VJ} = 150°C, R_G = 5Ω Clamped Inductive Load	I_{CM} = 80 V_{CE} ≤ 0.8 • V_{CES}	A
P_C	T_C = 25°C	600	W
T_J		-55 ... +175	°C
T_{JM}		175	°C
T_{stg}		-55 ... +175	°C
T_L	Maximum Lead Temperature for Soldering 1.6 mm (0.062 in.) from Case for 10s	300	°C
M_d	Mounting Torque	1.13 / 10	Nm/lb.in
Weight		6	g

Symbol	Test Conditions (T_J = 25°C, Unless Otherwise Specified)	Characteristic Values Min.	Typ.	Max.	
BV_{CES}	I_C = 250μA, V_{GE} = 0V	1200			V
$V_{GE(th)}$	I_C = 250μA, V_{CE} = V_{GE}	4.0		6.5	V
I_{CES}	V_{CE} = V_{CES}, V_{GE} = 0V			10	μA
	T_J = 150°C			1	mA
I_{GES}	V_{CE} = 0V, V_{GE} = ±20V			±100	nA
$V_{CE(sat)}$	I_C = 32A, V_{GE} = 15V, Note 1		1.56	1.80	V
	T_J = 150°C		1.80		V

Features

- Optimized for Low Conduction
- Positive Thermal Coefficient of Vce(sat)
- International Standard Package

Advantages

- High Power Density
- Low Gate Drive Requirement

Applications

- Power Inverters
- UPS
- Motor Drives
- SMPS
- PFC Circuits
- Battery Chargers
- Welding Machines
- Lamp Ballasts
- Inrush Current Protection Circuits

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Symbol	Test Conditions (T_J = 25°C Unless Otherwise Specified)	Characteristic Values Min.	Typ.	Max.	
g_{fs}	I_C = 32A, V_{CE} = 10V, Note 1	12	22		S
C_{ies}	V_{CE} = 25V, V_{GE} = 0V, f = 1MHz		1650		pF
C_{oes}			105		pF
C_{res}			60		pF
$Q_{g(on)}$	I_C = 32A, V_{GE} = 15V, V_{CE} = 0.5 • V_{CES}		90		nC
Q_{ge}			15		nC
Q_{gc}			40		nC
$t_{d(on)}$	**Inductive load, T_J = 25°C**		22		ns
t_{ri}	I_C = 32A, V_{GE} = 15V		50		ns
E_{on}	V_{CE} = 600V, R_G = 5Ω		2.30		mJ
$t_{d(off)}$	Note 2		204		ns
t_{fi}			346		ns
E_{off}			3.75		mJ
$t_{d(on)}$	**Inductive load, T_J = 150°C**		17		ns
t_{ri}	I_C = 32A, V_{GE} = 15V		50		ns
E_{on}	V_{CE} = 600V, R_G = 5Ω		3.55		mJ
$t_{d(off)}$	Note 2		280		ns
t_{fi}			760		ns
E_{off}			6.46		mJ
R_{thJC}				0.25	°C/W
R_{thCS}			0.21		°C/W

Notes:

1. Pulse test, t ≤ 300µs, duty cycle, d ≤ 2%.
2. Switching times & energy losses may increase for higher V_{CE}(clamp), T_J or R_G.

Littelfuse Reserves the Right to Change Limits, Test Conditions, and Dimensions.

IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents: 4,835,592 4,931,844 5,049,961 5,237,481 6,162,665 6,404,065 B1 6,683,344 6,727,585 7,005,734 B2 7,157,338B2 4,860,072 5,017,508 5,063,307 5,381,025 6,259,123 B1 6,534,343 6,710,405 B2 6,759,692 7,063,975 B2 4,881,106 5,034,796 5,187,117 5,486,715 6,306,728 B1 6,583,505 6,710,463 6,771,478 B2 7,071,537

Fig. 1. Output Characteristics @ T_J = 25°C

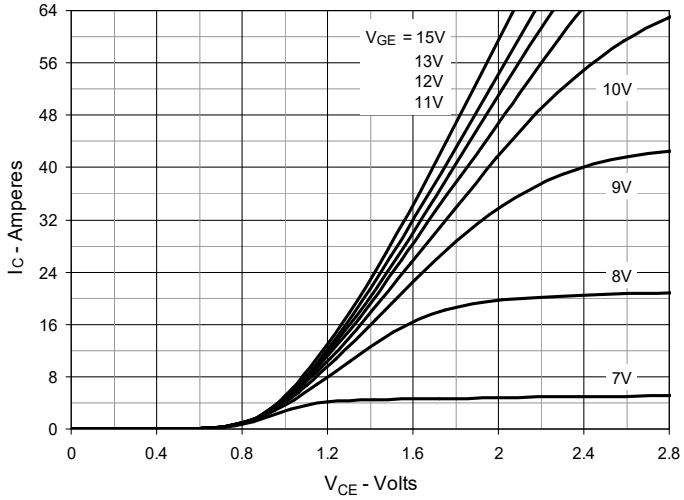

Fig. 2. Extended Output Characteristics @ T_J = 25°C

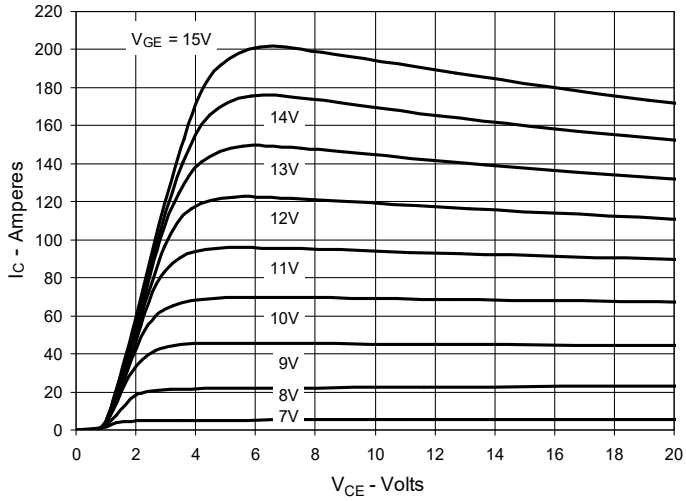

Fig. 3. Output Characteristics @ T_J = 150°C

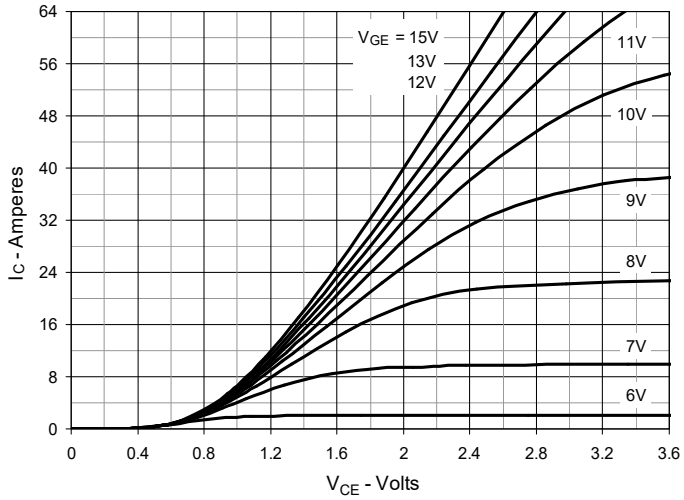

Fig. 4. Dependence of $V_{CE(sat)}$ on Junction Temperature

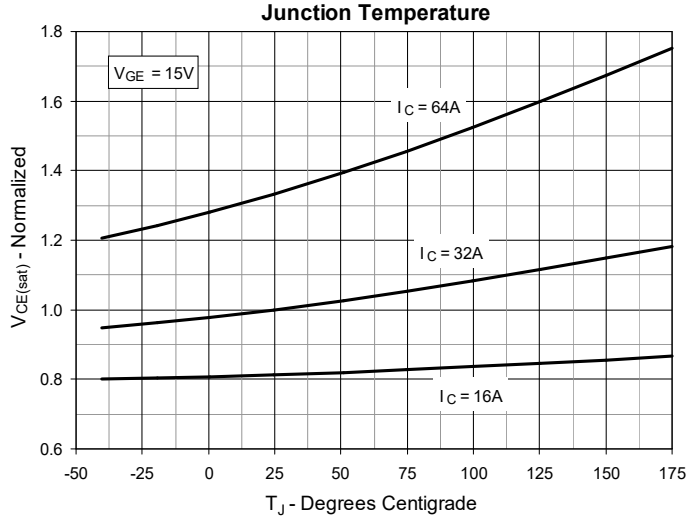

Fig. 5. Collector-to-Emitter Voltage vs. Gate-to-Emitter Voltage

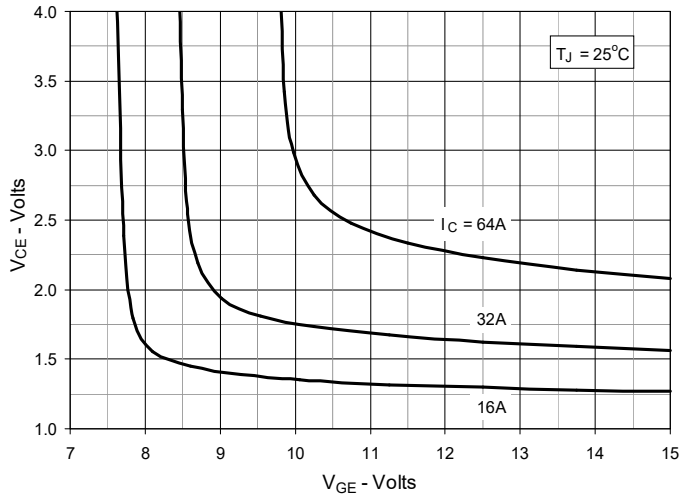

Fig. 6. Input Admittance

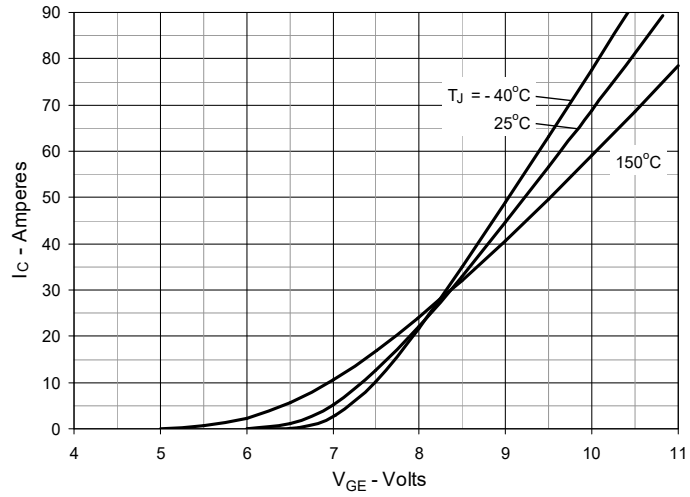

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Fig. 7. Transconductance

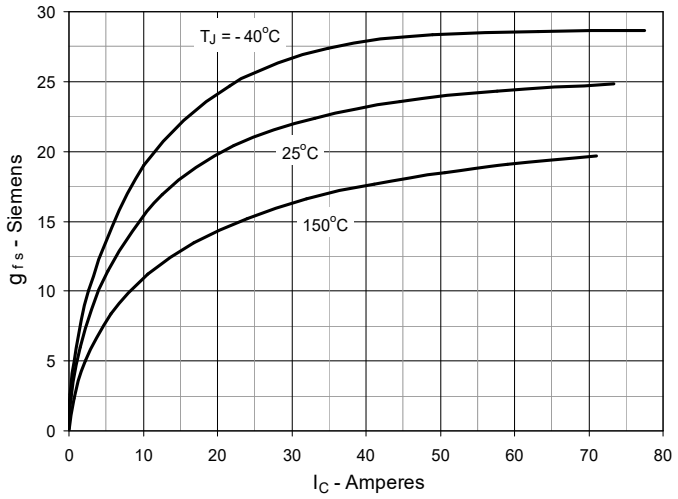

Fig. 8. Gate Charge

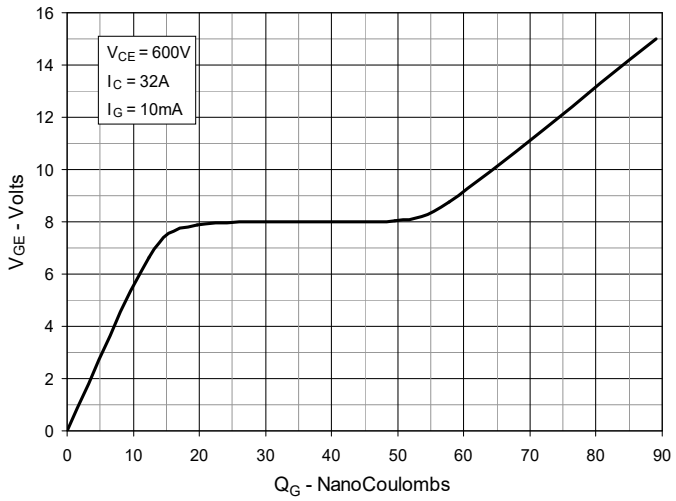

Fig. 9. Capacitance

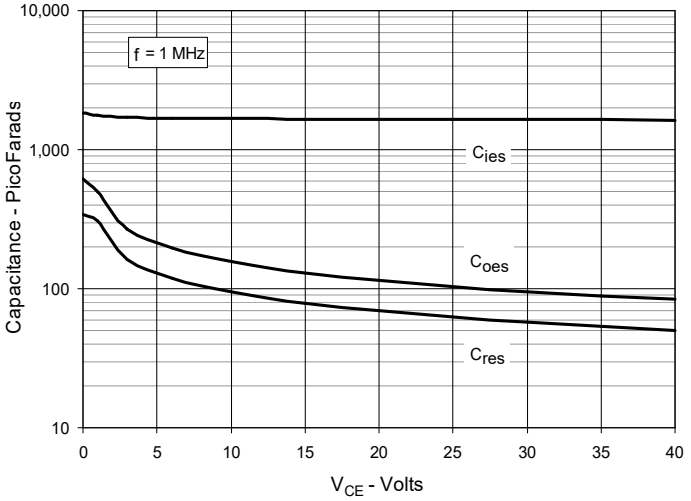

Fig. 10. Reverse-Bias Safe Operating Area

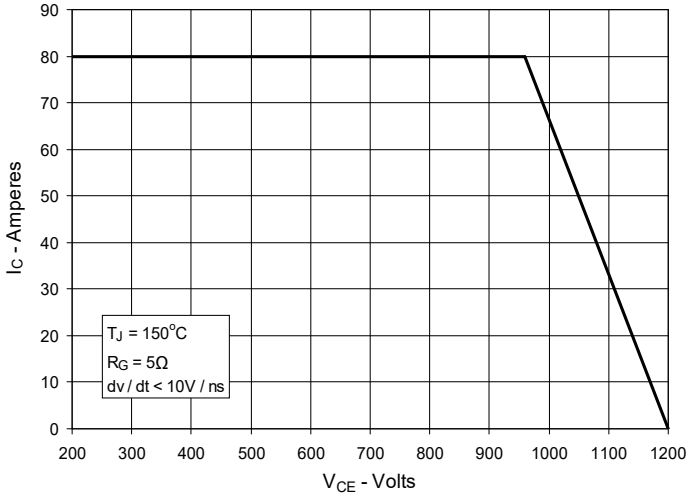

Fig. 11. Maximum Transient Thermal Impedance

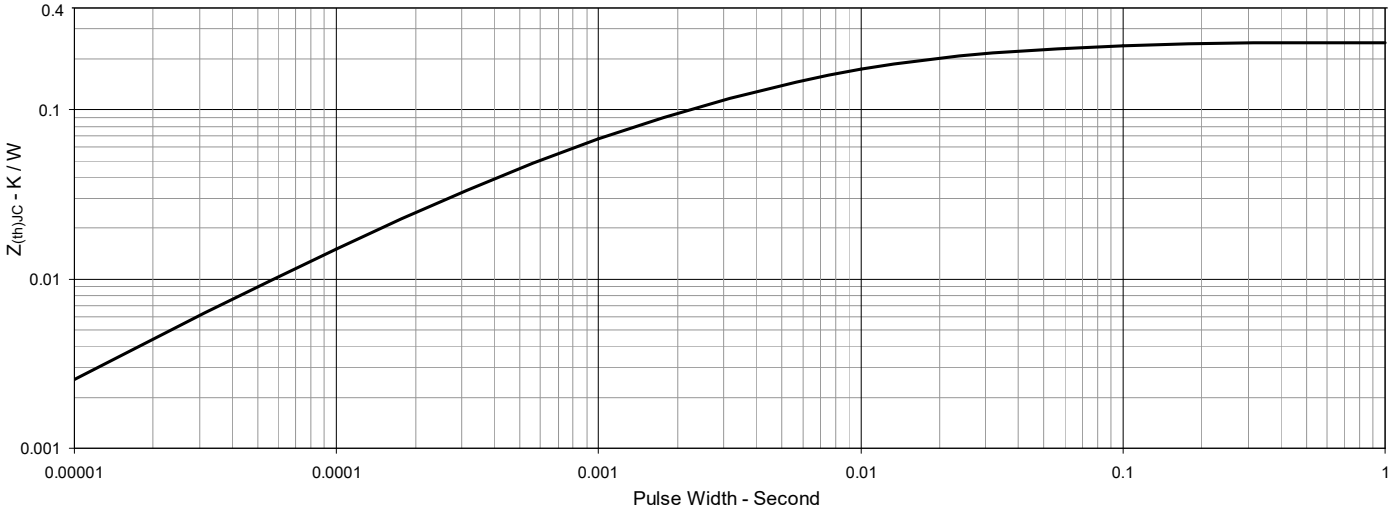

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Fig. 12. Inductive Switching Energy Loss vs. Collector Current

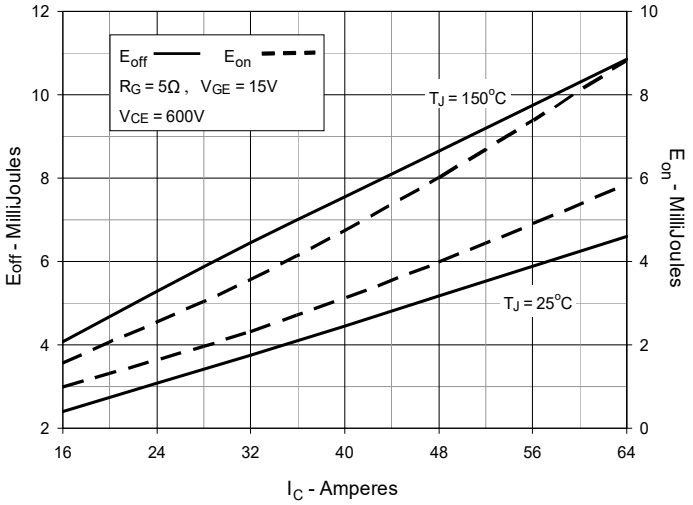

Fig. 13. Inductive Switching Energy Loss vs. Collector-Emitter Voltage

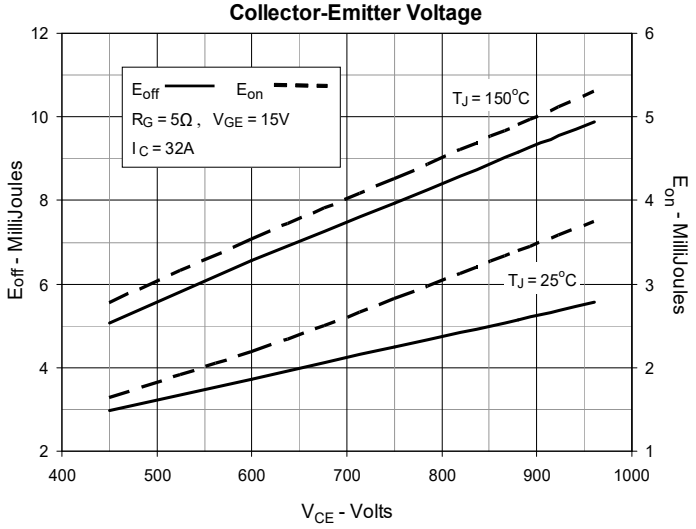

Fig. 14. Inductive Switching Energy Loss vs. Gate Resistance

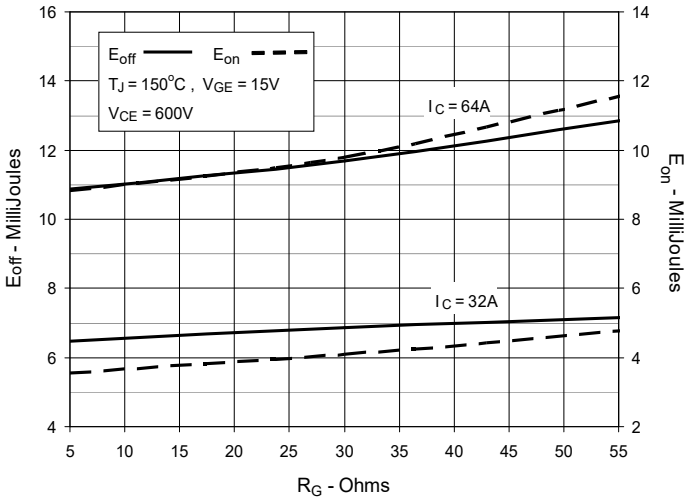

Fig. 15. Inductive Switching Energy Loss vs. Junction Temperature

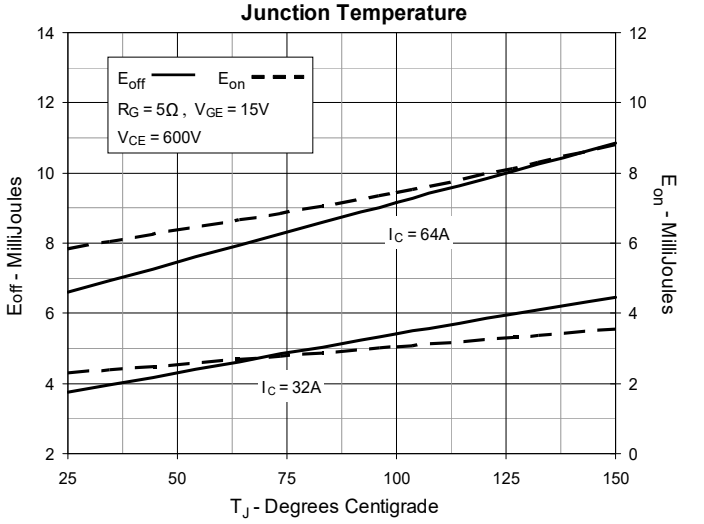

Fig. 16. Inductive Turn-off Switching Times vs. Gate Resistance

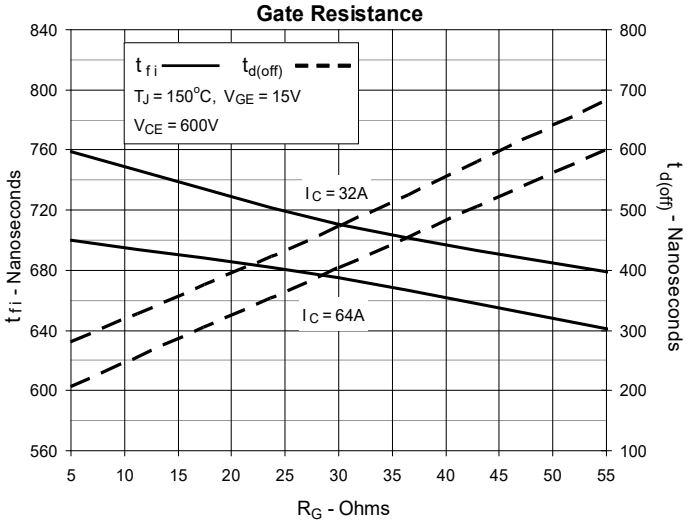

Fig. 17. Inductive Turn-off Switching Times vs. Collector Current

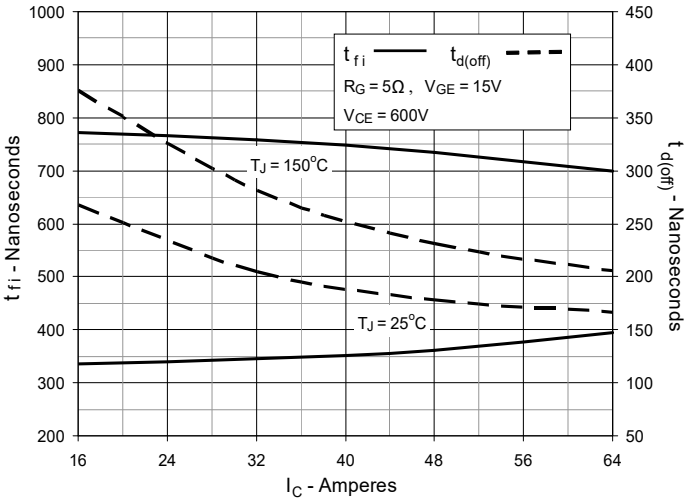

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Fig. 18. Inductive Turn-off Switching Times vs. Junction Temperature

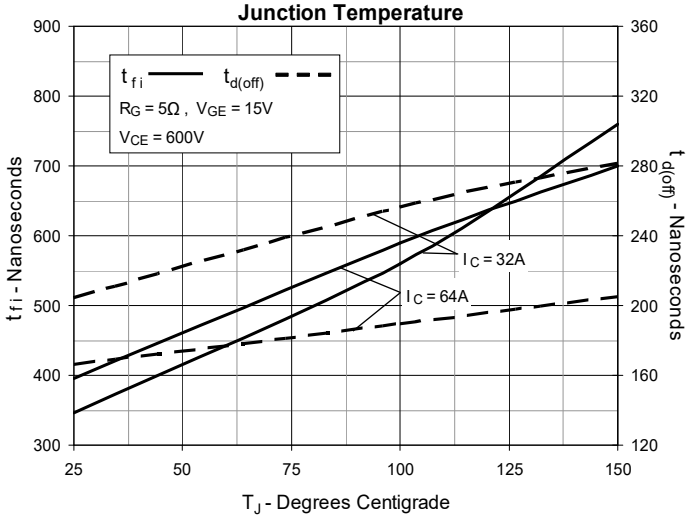


Fig. 19. Inductive Turn-on Switching Times vs. Gate Resistance

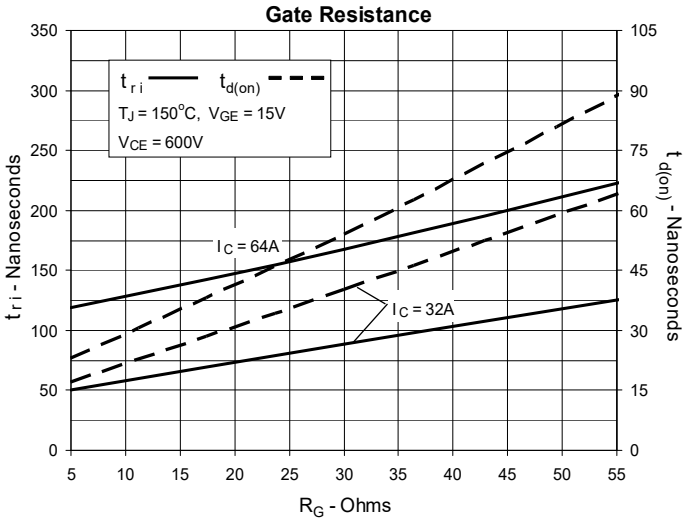


Fig. 20. Inductive Turn-on Switching Times vs. Collector Current

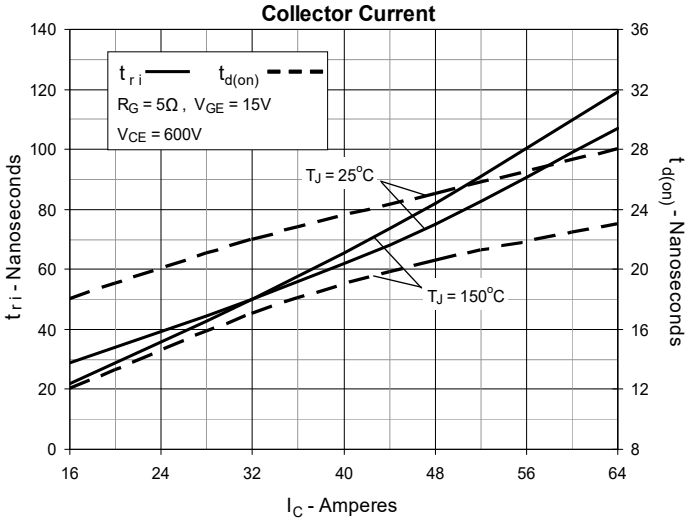
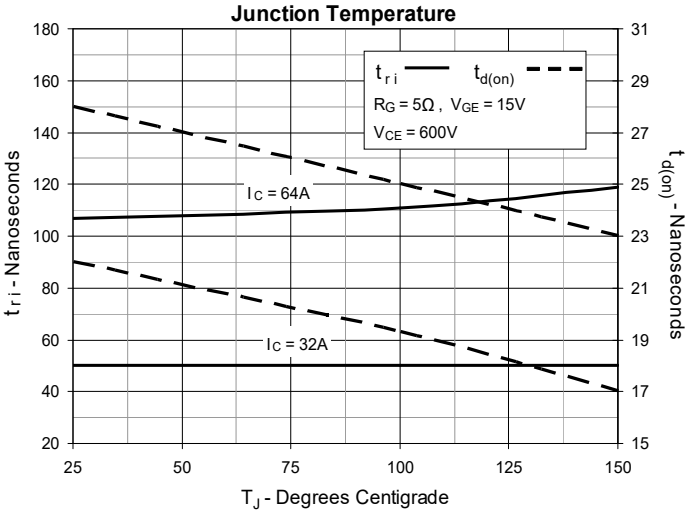


Fig. 21. Inductive Turn-on Switching Times vs. Junction Temperature



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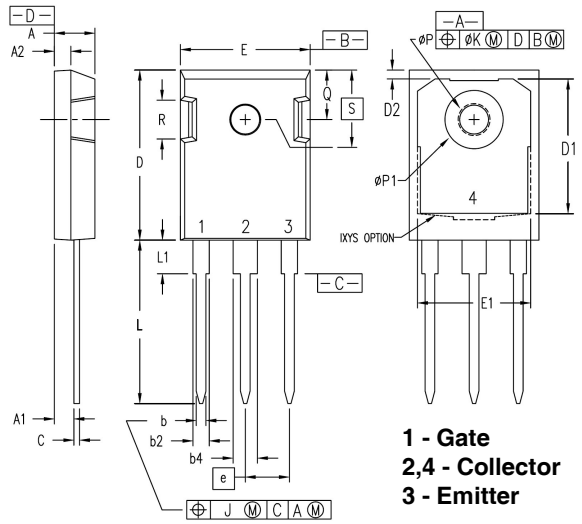
TO-247 Outline



1 - Gate
2,4 - Collector
3 - Emitter

SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.190	.205	4.83	5.21
A1	.090	.100	2.29	2.54
A2	.075	.085	1.91	2.16
b	.045	.055	1.14	1.40
b2	.075	.087	1.91	2.20
b4	.115	.126	2.92	3.20
C	.024	.031	0.61	0.80
D	.819	.840	20.80	21.34
D1	.650	.690	16.51	17.53
D2	.035	.050	0.89	1.27
E	.620	.635	15.75	16.13
E1	.545	.565	13.84	14.35
e	.215 BSC		5.45 BSC	
J	--	.010	--	0.25
K	--	.025	--	0.64
L	.780	.810	19.81	20.57
L1	.150	.170	3.81	4.32
øP	.140	.144	3.55	3.65
øP1	.275	.290	6.99	7.37
Q	.220	.244	5.59	6.20
R	.170	.190	4.32	4.83
S	.242 BSC		6.15 BSC	

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